# 2SD2178

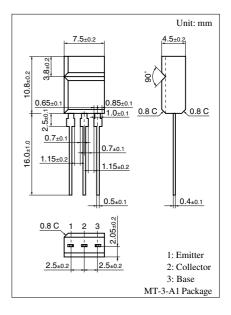
### Silicon NPN epitaxial planar type

For low-frequency output amplification

#### Features

- $\bullet$  Low collector to emitter saturation voltage  $V_{CE(sat)}$
- $\bullet$  Large collector current  $I_{C}$

Absolute Maximum Hatings $T_a = 23$ C							
Symbol	Rating	Unit					
V <sub>CBO</sub>	50	V					
V <sub>CEO</sub>	50	V					
V <sub>EBO</sub>	5	V					
I <sub>CP</sub>	3	А					
I <sub>C</sub>	2	А					
P <sub>C</sub>	1.5	W					
Tj	150	°C					
T <sub>stg</sub>	-55 to +150	°C					
	$\begin{tabular}{ c c c c } \hline Symbol \\ \hline V_{CBO} \\ \hline V_{CEO} \\ \hline V_{EBO} \\ \hline I_{CP} \\ \hline I_{C} \\ \hline P_{C} \\ \hline T_{j} \\ \hline \end{tabular}$	Symbol      Rating        V <sub>CBO</sub> 50        V <sub>CEO</sub> 50        V <sub>EBO</sub> 5        I <sub>CP</sub> 3        I <sub>C</sub> 2        P <sub>C</sub> 1.5        T <sub>j</sub> 150					



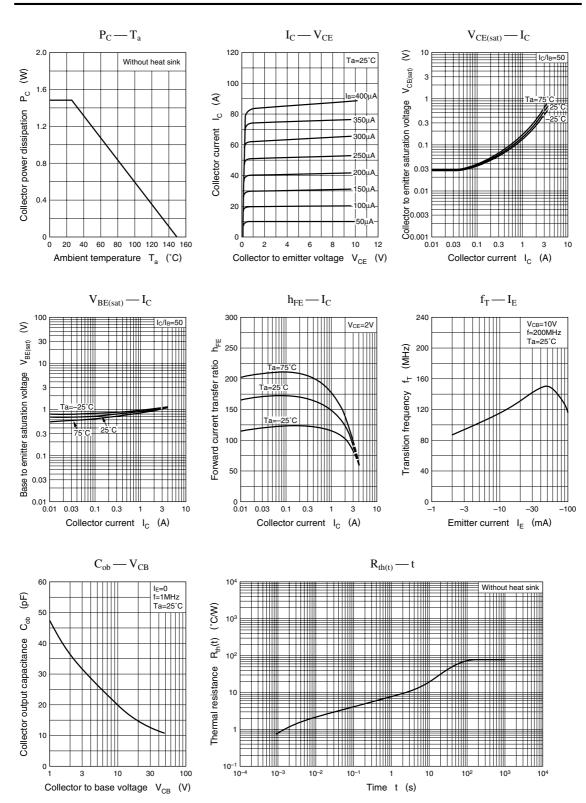
#### Absolute Maximum Ratings $T_a = 25^{\circ}C$

#### Electrical Characteristics $T_C = 25^{\circ}C$

Parameter	Symbol	Conditions	Min	Тур	Мах	Unit
Collector cutoff current	I <sub>CBO</sub>	$V_{CB} = 20 \text{ V}, I_E = 0$			0.1	μΑ
Collector to base voltage	V <sub>CBO</sub>	$I_{\rm C} = 10 \ \mu A, \ I_{\rm E} = 0$	50			V
Collector to emitter voltage	V <sub>CEO</sub>	$I_{\rm C} = 1 \text{ mA}, I_{\rm B} = 0$	50			V
Emitter to base voltage	V <sub>EBO</sub>	$I_E = 10 \ \mu A, \ I_C = 0$	5			V
Forward current transfer ratio	h <sub>FE1</sub> *	$V_{CE} = 2 V, I_C = 200 mA$	120		340	
	h <sub>FE2</sub>	$V_{CE} = 2 V, I_C = 1.0 A$	80			
Collector to emitter saturation voltage	V <sub>CE(sat)</sub>	$I_{\rm C} = 1 \text{ A}, I_{\rm B} = 50 \text{ mA}$		0.15	0.3	V
Base to emitter saturation voltage	V <sub>BE(sat)</sub>	$I_{\rm C} = 1 \text{ A}, I_{\rm B} = 50 \text{ mA}$		0.9	1.2	V
Transition frequency	$f_{T}$	$V_{CE} = 10 \text{ V}, I_E = -50 \text{ mA}, f = 200 \text{ MHz}$		150		MHz
Collector output capacitance	C <sub>ob</sub>	$V_{CB} = 10 \text{ V}, I_E = 0, f = 1 \text{ MHz}$		23	35	pF

Note) \*: Rank classification

Rank	R	S
h <sub>FE1</sub>	120 to 240	170 to 340



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